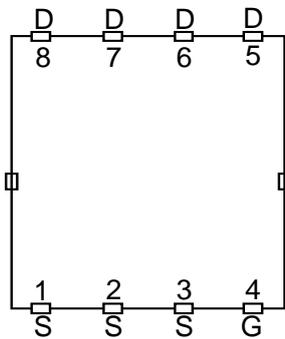


**Description**

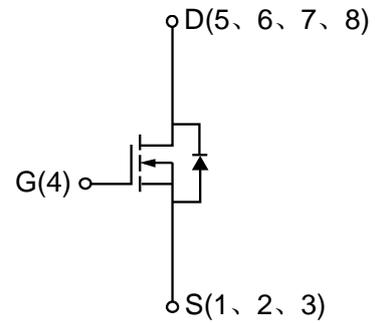
The MOSFET provide the best combination of fast switching, low on-resistance and cost-effectiveness.

MOSFET Product Summary		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (mΩ)	I <sub>D</sub> (A)
30	<9.5 @ V <sub>GS</sub> =4.5V	50
	<6.6 @ V <sub>GS</sub> =10V	

Top View (PDFN3.3\*3.3-8L )



Internal Structure



**Absolute maximum ratings @ T<sub>A</sub>=25°C unless otherwise specified**

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V <sub>DSS</sub>	30	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current(V <sub>GS</sub> =10V)	I <sub>D</sub>	T <sub>A</sub> =25°C	12
		T <sub>A</sub> =70°C	9.5
300µs Pulsed Drain Current(V <sub>GS</sub> =10V)	I <sub>DM</sub>	40	A
Continuous Drain Current(V <sub>GS</sub> =10V)	I <sub>D</sub>	T <sub>C</sub> =25°C	50
		T <sub>C</sub> =70°C	38
300µs Pulsed Drain Current(V <sub>GS</sub> =10V)	I <sub>DM</sub>	165	A
Diode Continuous Forward Current	I <sub>S</sub>	2	A
Avalanche Current, Single pulse (L=0.1mH)	I <sub>AS</sub>	25	A
Avalanche Energy, Single pulse (L=0.1mH)	E <sub>AS</sub>	31.25	mJ
Maximum Power Dissipation	P <sub>D</sub>	T <sub>A</sub> =25°C	1.6
		T <sub>A</sub> =70°C	1
Maximum Power Dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	29
		T <sub>C</sub> =70°C	19
Maximum Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	t ≤ 10s	35
		Steady State	60
Thermal Resistance-Junction to Case	R <sub>θJC</sub>	3.5	°C/W

Electrical characteristics per line @25°C ( unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_{DS}=250 \mu A, V_{GS}=0V$	30	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V$	-	-	1	$\mu A$
		$T_J=85^\circ C$	-	-	30	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_{DS}=250 \mu A$	1.5	1.8	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_{DS}=12A$	-	5.5	6.6	$m\Omega$
		$V_{GS}=4.5V, I_{DS}=9A$	-	7.3	9.5	
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_{SD}=2A$	-	0.8	1.1	V
Total Gate Charge	$Q_g$	$V_{GS}=10V, V_{DS}=15V, I_D=12A$	-	28.3	39.6	nC
Total Gate Charge	$Q_g$	$V_{GS}=4.5V, V_{DS}=15V, I_{DS}=12A$	-	12.9	18	nC
Gate-Source Charge	$Q_{gs}$		-	4.22	5.9	
Gate-Drain Charge	$Q_{gd}$		-	7.3	10.2	
Input Capacitance	$C_{ISS}$	$V_{GS}=0V, V_{DS}=15V, f=1MHz$	1360	1700	2040	pF
Output Capacitance	$C_{OSS}$		185	265	345	
Reverse Transfer Capacitance	$C_{RSS}$		99	165	231	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=15V, V_{GEN}=10V, R_G=6\Omega, R_L=15\Omega, I_{DS}=1A$	-	14	26	ns
Turn-Off Delay Time	$t_{d(off)}$		-	44	80	
Turn-On Rise Time	$t_r$		-	10	19	
Turn-On Fall Time	$t_f$		-	12	23	
Gate-Resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	1.9	2.4	2.9	$\Omega$

Typical Characteristics

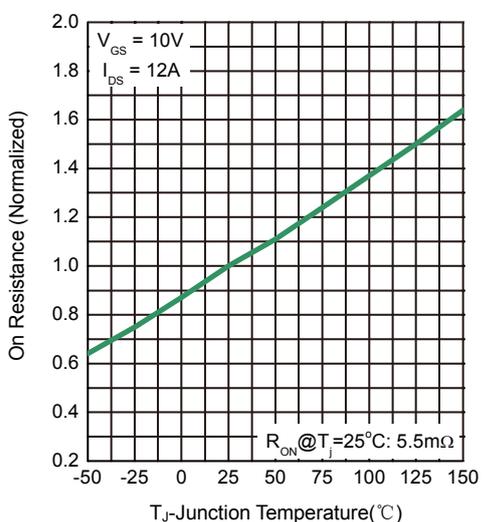


Fig 1. On Resistance vs. Junction Temperature

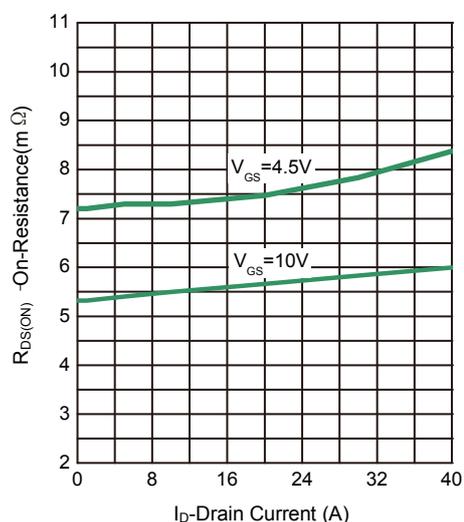


Fig 2. On-Resistance vs. Drain Current

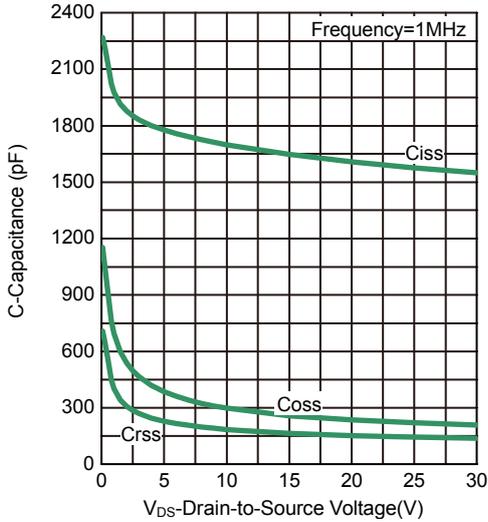


Fig 3. Capacitance

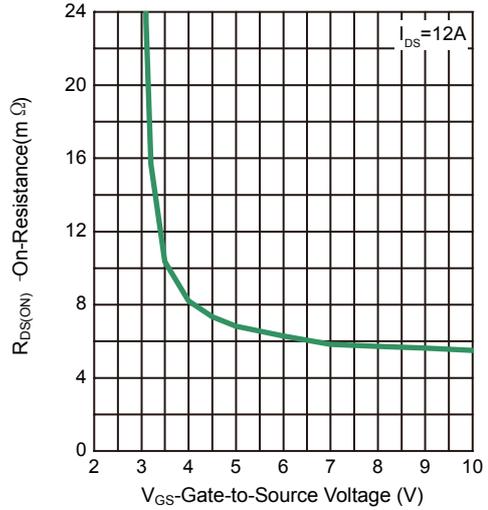


Fig 4. On-Resistance vs. Gate-to-Source Voltage

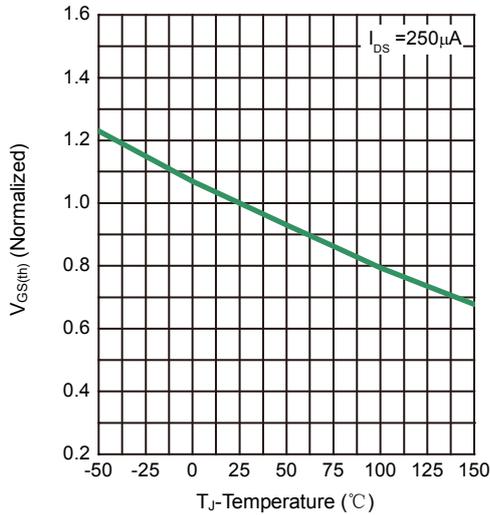


Fig 5. Threshold Voltage

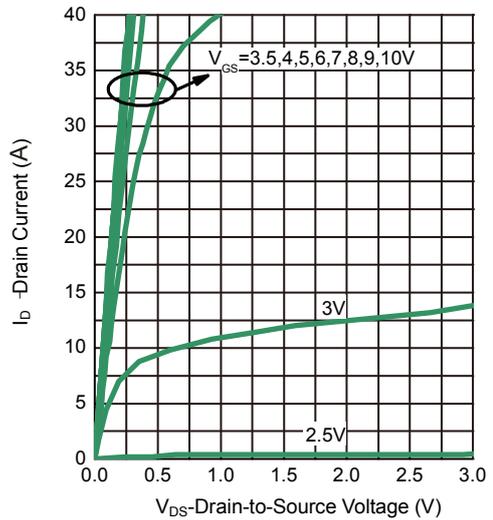


Fig 6. On-Region Characteristics

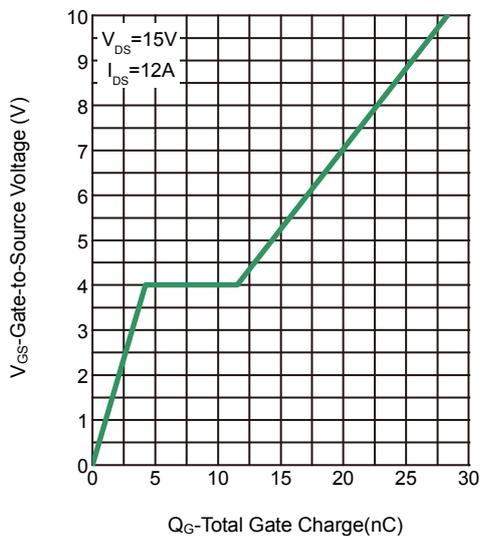


Fig 7. Gate Charge

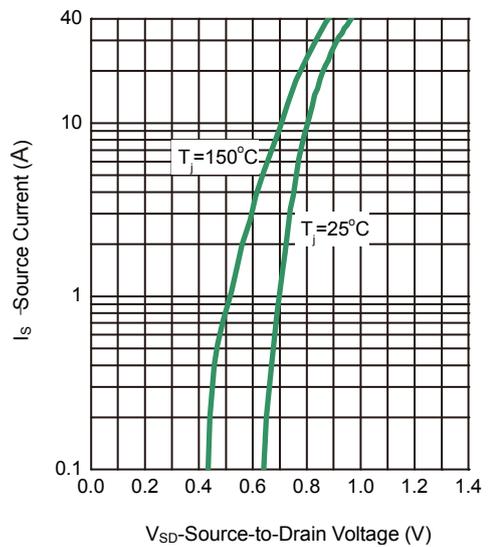


Fig 8. Source to Drain Diode Forward Voltage

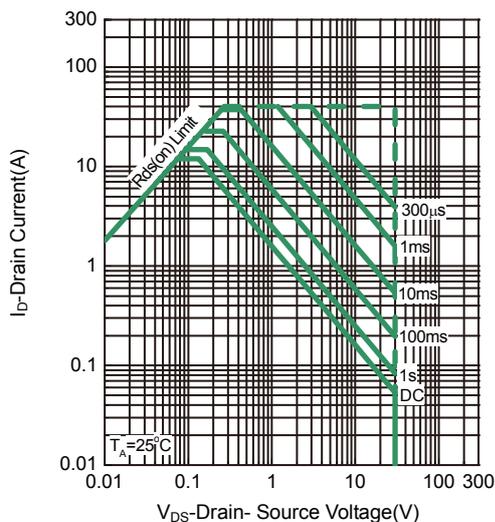


Fig 9. Maximum Forward Biased Safe Operating Area

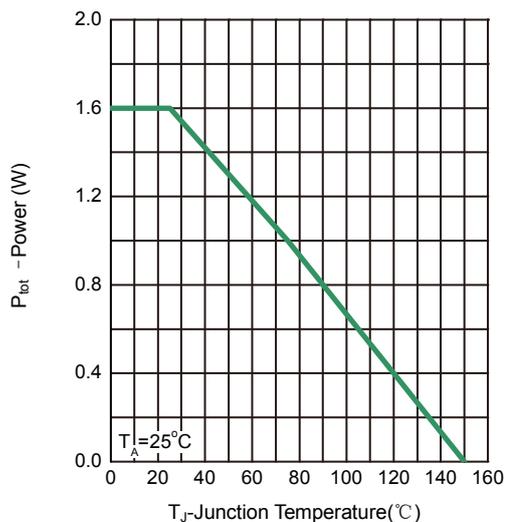


Fig 10. Power Dissipation

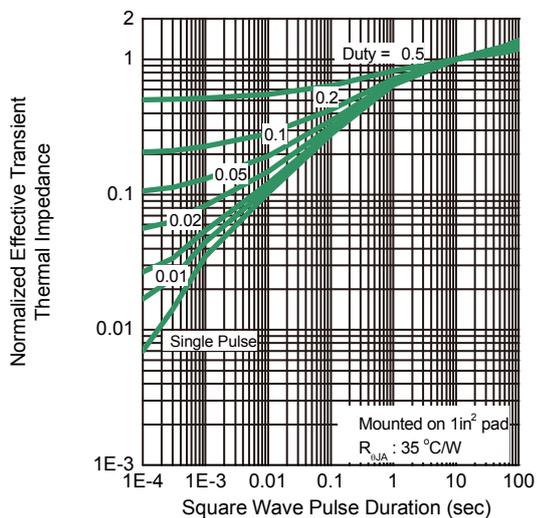
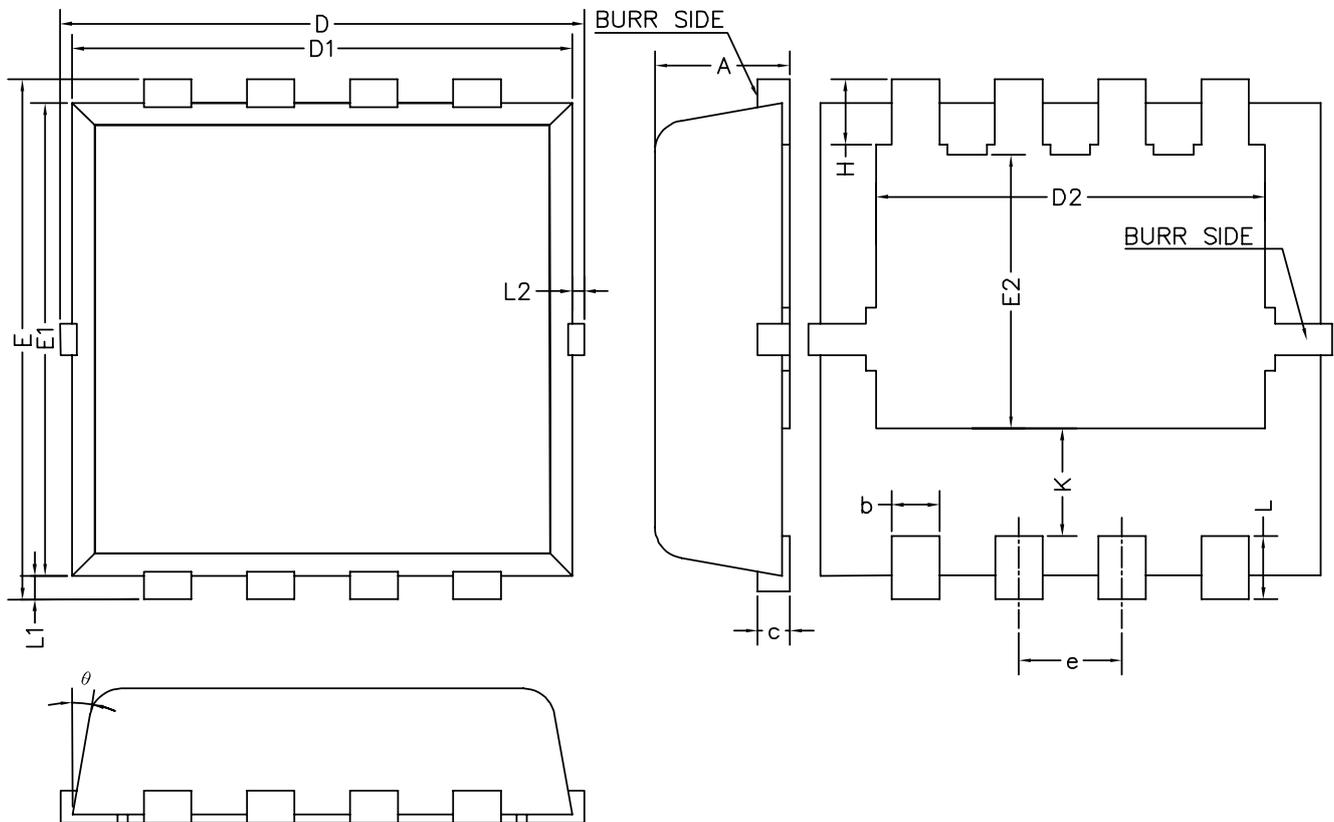


Fig 11. Normalized Thermal Transient Impedance, Junction-to-Ambient

Product dimension (PDFN3.3\*3.3-8L)



Dim	Millimeters		
	MIN	MAX	MAX
A	0.70	0.80	0.90
b	0.25	0.30	0.35
c	0.14	0.15	0.20
D	3.10	3.30	3.50
D1	3.05	3.15	3.25
D2	2.35	2.45	2.55
e	0.55	0.65	0.75
E	3.10	3.30	3.50
E1	2.90	3.00	3.10
E2	1.64	1.74	1.84
H	0.32	0.42	0.52
K	0.59	0.69	0.79
L	0.25	0.40	0.55
L1	0.10	0.15	0.20
L2	—	—	0.15
θ	8°	12°	12°

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